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Team Nexperia

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

Rev. 5 — 21 December 2011

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

PNP Resistor-Equipped Transistor (RET) family in small Surface-Mounted Device (SMD) plastic packages.

#### Table 1. Product overview

| Type number | Package | -      |          |            | Package              |
|-------------|---------|--------|----------|------------|----------------------|
|             | NXP     | JEITA  | JEDEC    | complement | configuration        |
| PDTA123JE   | SOT416  | SC-75  | -        | PDTC123JE  | ultra small          |
| PDTA123JM   | SOT883  | SC-101 | -        | PDTC123JM  | leadless ultra small |
| PDTA123JT   | SOT23   | -      | TO-236AB | PDTC123JT  | small                |
| PDTA123JU   | SOT323  | SC-70  | -        | PDTC123JU  | very small           |

#### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

#### **1.3 Applications**

- Digital application in automotive and industrial segments
- Control of IC inputs

- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified
- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

#### 1.4 Quick reference data

#### Table 2. Quick reference data

| Symbol           | Parameter                 | Conditions | Min  | Тур  | Max  | Unit |
|------------------|---------------------------|------------|------|------|------|------|
| V <sub>CEO</sub> | collector-emitter voltage | open base  | -    | -    | -50  | V    |
| I <sub>O</sub>   | output current            |            | -    | -    | -100 | mA   |
| R1               | bias resistor 1 (input)   |            | 1.54 | 2.20 | 2.86 | kΩ   |
| R2/R1            | bias resistor ratio       |            | 17   | 21   | 26   |      |



PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

## 2. Pinning information

| Pin      | Description        | Simplified outline        | Graphic symbol       |
|----------|--------------------|---------------------------|----------------------|
| SOT23; S | SOT323; SOT416     |                           |                      |
| 1        | input (base)       | _                         |                      |
| 2        | GND (emitter)      | 3                         |                      |
| 3        | output (collector) | 1 2<br>006aaa144          | 1 R1<br>R2<br>sym003 |
| SOT883   |                    |                           |                      |
| 1        | input (base)       |                           |                      |
| 2        | GND (emitter)      |                           |                      |
| 3        | output (collector) | 2 Transparent<br>top view | 1 R1 R2 Sym003       |

## 3. Ordering information

| Type number | Package |   |         |
|-------------|---------|---|---------|
|             | Name    | Description   | Version |
| PDTA123JE   | SC-75   | plastic surface-mounted package; 3 leads  | SOT416  |
| PDTA123JM   | SC-101  | leadless ultra small plastic package; 3 solder lands; body 1.0 $\times$ 0.6 $\times$ 0.5 mm | SOT883  |
| PDTA123JT   | -       | plastic surface-mounted package; 3 leads  | SOT23   |
| PDTA123JU   | SC-70   | plastic surface-mounted package; 3 leads  | SOT323  |

### 4. Marking

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PDTA123JE   | 27                          |
| PDTA123JM   | DG                          |
| PDTA123JT   | *23                         |
| PDTA123JU   | *43                         |

[1] \* = placeholder for manufacturing site code.

PDTA123J\_SER Product data sheet

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

### 5. Limiting values

| Table 6.<br>In accorda | Limiting values<br>ance with the Absolute Maxim | num Rating System (IEC 60            | 0134).     |     |      |      |
|------------------------|---|--------------------------------------|------------|-----|------|------|
| Symbol                 | Parameter                                       | Conditions                           |            | Min | Max  | Unit |
| V <sub>CBO</sub>       | collector-base voltage                          | open emitter                         |            | -   | -50  | V    |
| V <sub>CEO</sub>       | collector-emitter voltage                       | open base                            |            | -   | -50  | V    |
| V <sub>EBO</sub>       | emitter-base voltage                            | open collector                       |            | -   | -10  | V    |
| VI                     | input voltage                                   |                                      |            |     |      |      |
|                        | positive  |                                      |            | -   | +5   | V    |
|                        | negative  |                                      |            | -   | -12  | V    |
| lo                     | output current                                  |                                      |            | -   | -100 | mA   |
| I <sub>CM</sub>        | peak collector current                          | single pulse; $t_p \le 1 \text{ ms}$ |            | -   | -100 | mA   |
| P <sub>tot</sub>       | total power dissipation                         | $T_{amb} \le 25 \ ^{\circ}C$         |            |     |      |      |
|                        | PDTA123JE (SOT416)                              |                                      | [1][2]     | -   | 150  | mW   |
|                        | PDTA123JM (SOT883)                              |                                      | [2][3]     | -   | 250  | mW   |
|                        | PDTA123JT (SOT23)                               |                                      | <u>[1]</u> | -   | 250  | mW   |
|                        | PDTA123JU (SOT323)                              |                                      | <u>[1]</u> | -   | 200  | mW   |
| Tj                     | junction temperature                            |                                      |            | -   | 150  | °C   |
| T <sub>amb</sub>       | ambient temperature                             |                                      |            | -65 | +150 | °C   |
| T <sub>stg</sub>       | storage temperature                             |                                      |            | -65 | +150 | °C   |

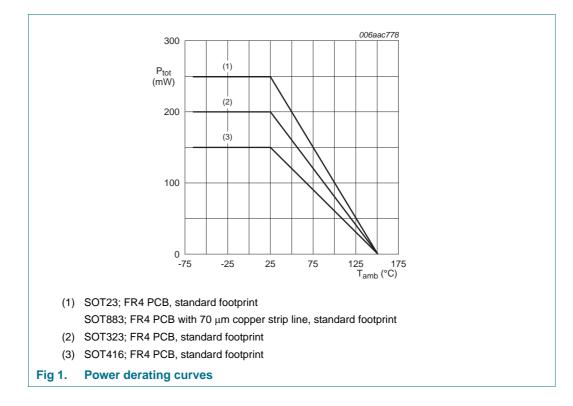
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 µm copper strip line, standard footprint.

PDTA123J\_SER Product data sheet

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 



### 6. Thermal characteristics

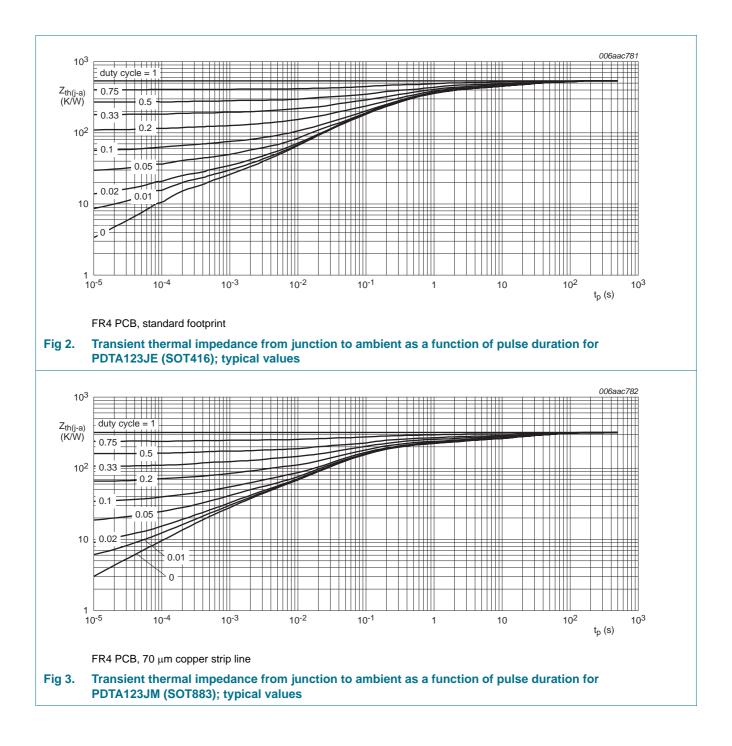
| Table 7.             | Thermal characteristics                     |             |               |     |     |      |
|----------------------|---|-------------|---------------|-----|-----|------|
| Symbol               | Parameter                                   | Conditions  | Min           | Тур | Max | Unit |
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air |               |     |     |      |
|                      | PDTA123JE (SOT416)                          |             | <u>[1][2]</u> | -   | 830 | K/W  |
|                      | PDTA123JM (SOT883)                          |             | [2][3]        | -   | 500 | K/W  |
|                      | PDTA123JT (SOT23)                           |             | <u>[1]</u> -  | -   | 500 | K/W  |
|                      | PDTA123JU (SOT323)                          |             | <u>[1]</u> -  | -   | 625 | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

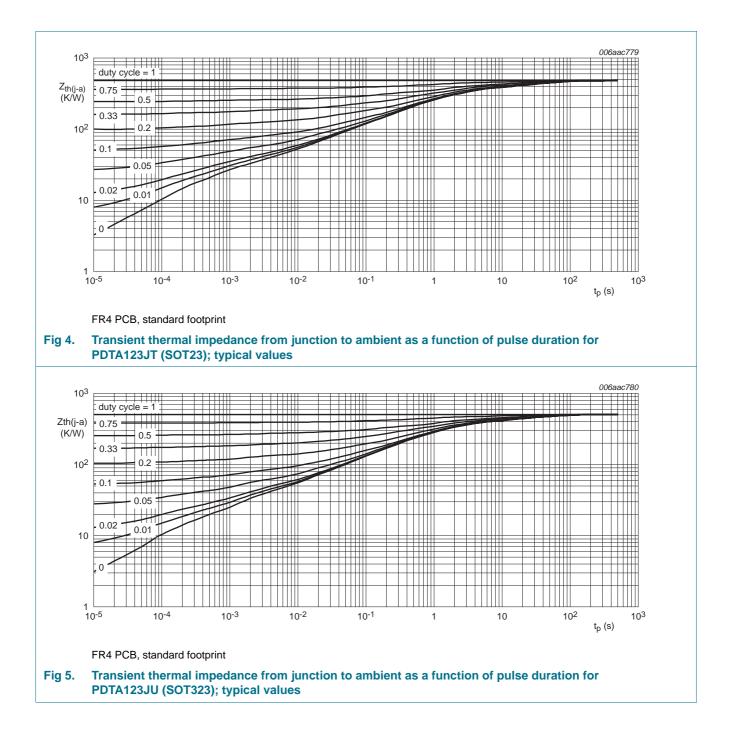
[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70  $\mu$ m copper strip line, standard footprint.

## **PDTA123J series**



## **PDTA123J series**



PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

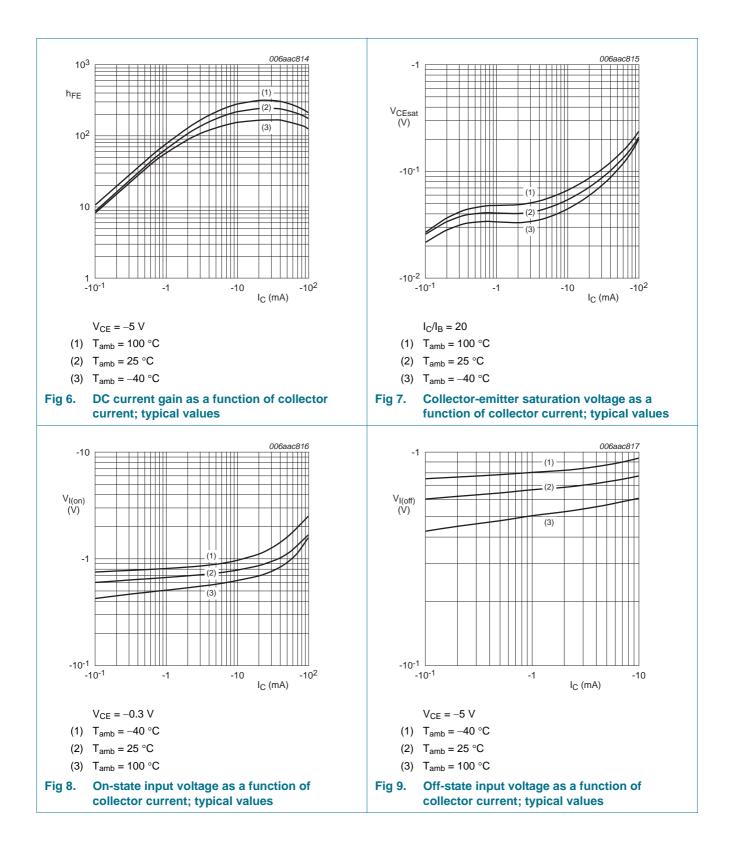
### 7. Characteristics

| Table 8. $T_{amb} = 25$ | Characteristics<br>°C unless otherwise sp | ecified.   |              |       |      |      |
|-------------------------|---|--|--------------|-------|------|------|
| Symbol                  | Parameter                                 | Conditions   | Min          | Тур   | Max  | Unit |
| I <sub>CBO</sub>        | collector-base<br>cut-off current         | $V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$  | -            | -     | -100 | nA   |
| I <sub>CEO</sub>        | collector-emitter                         | $V_{CE} = -30$ V; $I_B = 0$ A  | -            | -     | -1   | μΑ   |
|                         | cut-off current                           | $\label{eq:Vce} \begin{array}{l} V_{CE} = -30 \text{ V}; \text{ I}_{B} = 0 \text{ A}; \\ T_{j} = 150 \ ^{\circ}\text{C} \end{array}$ | -            | -     | -5   | μA   |
| I <sub>EBO</sub>        | emitter-base<br>cut-off current           | $V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$   | -            | -     | -180 | μΑ   |
| h <sub>FE</sub>         | DC current gain                           | $V_{CE}$ = -5 V; $I_C$ = -10 mA  | 100          | -     | -    |      |
| V <sub>CEsat</sub>      | collector-emitter saturation voltage      | $I_{C} = -5$ mA; $I_{B} = -0.25$ mA  | -            | -     | -100 | mV   |
| V <sub>I(off)</sub>     | off-state input<br>voltage                | $V_{CE} = -5 \text{ V; } I_C = -100  \mu\text{A}$  | -            | -0.6  | -0.5 | V    |
| V <sub>I(on)</sub>      | on-state input<br>voltage                 | $V_{CE} = -0.3 \text{ V}; \text{ I}_{C} = -5 \text{ mA}$   | -1.1         | -0.75 | -    | V    |
| R1                      | bias resistor 1 (input)                   |  | 1.54         | 2.20  | 2.86 | kΩ   |
| R2/R1                   | bias resistor ratio                       |  | 17           | 21    | 26   |      |
| C <sub>c</sub>          | collector capacitance                     | $\label{eq:VCB} \begin{array}{l} V_{CB} = -10 \ V; \ I_E = i_e = 0 \ A; \\ f = 1 \ MHz \end{array}$                                  | -            | -     | 3    | pF   |
| f <sub>T</sub>          | transition frequency                      | $V_{CE} = -5 \text{ V}; I_{C} = -10 \text{ mA};$<br>f = 100 MHz  | <u>[1]</u> - | 180   | -    | MHz  |

[1] Characteristics of built-in transistor.

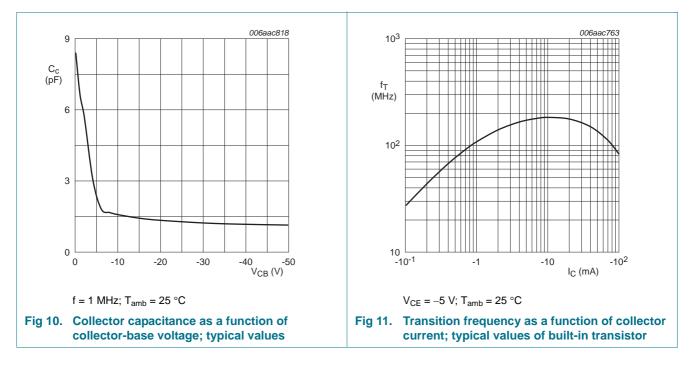
PDTA123J\_SER Product data sheet

## **PDTA123J series**



## **PDTA123J series**

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 



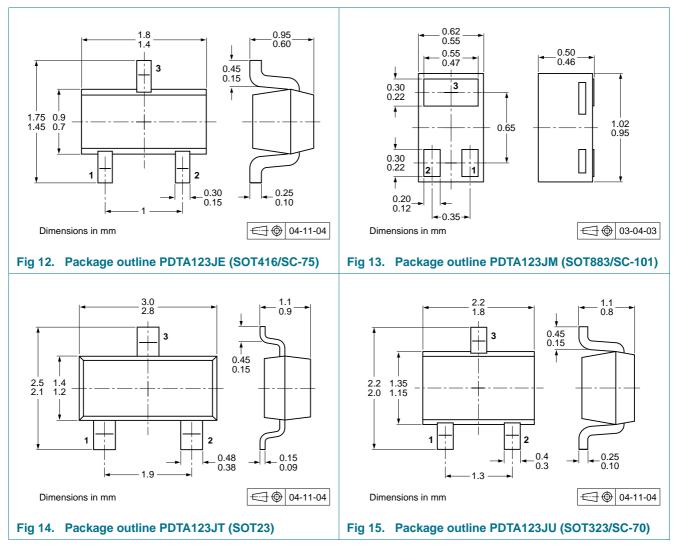
### 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

### 9. Package outline



### **10. Packing information**

#### Table 9. Packing methods

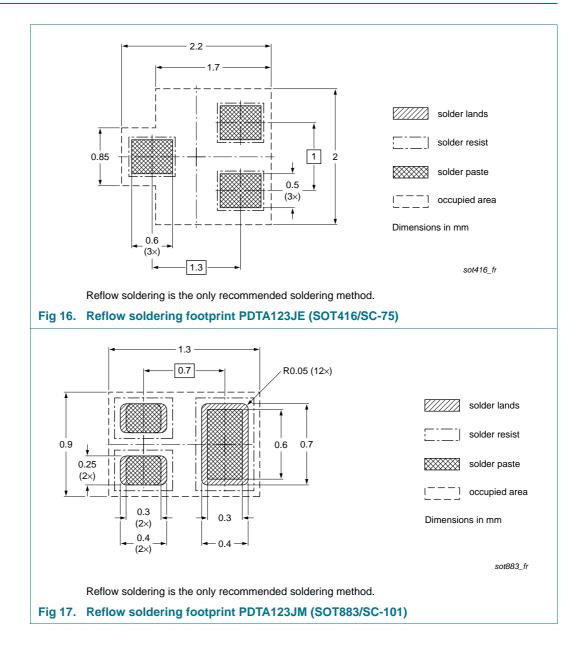
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

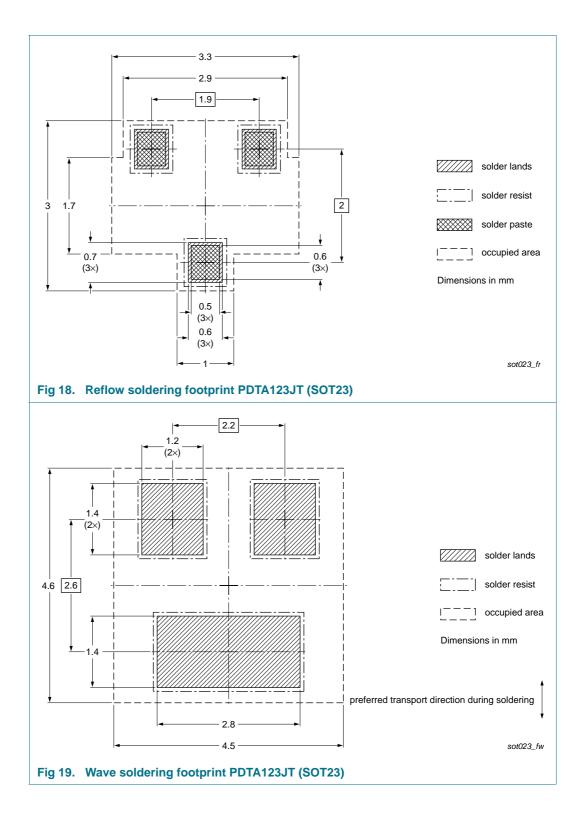
| Type number | Package | Description                    | Packing | quantity |
|-------------|---------|--------------------------------|---------|----------|
|             |         |                                | 3000    | 10000    |
| PDTA123JE   | SOT416  | 4 mm pitch, 8 mm tape and reel | -115    | -135     |
| PDTA123JM   | SOT883  | 2 mm pitch, 8 mm tape and reel | -       | -315     |
| PDTA123JT   | SOT23   | 4 mm pitch, 8 mm tape and reel | -215    | -235     |
| PDTA123JU   | SOT323  | 4 mm pitch, 8 mm tape and reel | -115    | -135     |

[1] For further information and the availability of packing methods, see Section 14.

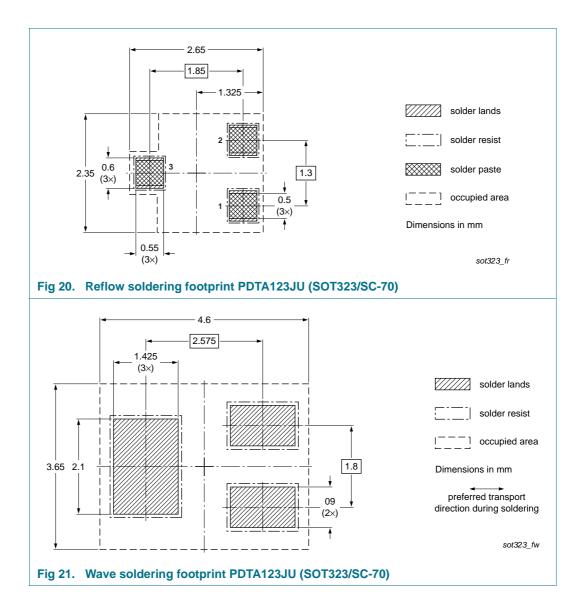
PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

### 11. Soldering





#### PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$



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Product data sheet

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PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$ 

### 12. Revision history

| Document ID         | Release date  | Data sheet status                              | Change notice        | Supersedes            |  |  |
|---------------------|---|--|----------------------|-----------------------|--|--|
| PDTA123J_SER v.5    | 20111221  | Product data sheet                             | -                    | PDTA123J_SERIES v.4   |  |  |
| Modifications:      |   | f this data sheet has been NXP Semiconductors. | redesigned to comply | with the new identity |  |  |
|                     | <ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>  |  |                      |                       |  |  |
|                     | <ul> <li>Type numbers PDTA123JEF, PDTA123JK and PDTA123JS removed</li> </ul>  |  |                      |                       |  |  |
|                     | <ul> <li><u>Section 1 "Product profile"</u>: amended</li> </ul>   |  |                      |                       |  |  |
|                     | • Figure 1 to 11: added   |  |                      |                       |  |  |
|                     | • <u>Table 8 "Characteristics</u> ": $V_{i(on)}$ redefined to $V_{I(on)}$ on-state input voltage, $V_{i(off)}$ redefined to $V_{I(off)}$ off-state input voltage, $I_{CEO}$ updated and $f_T$ added |  |                      |                       |  |  |
|                     | <ul> <li>Figure 12, 13, 14 and 15: superseded by minimized package outline drawings</li> </ul>  |  |                      |                       |  |  |
|                     | <ul> <li><u>Section 8 "Test information"</u>: added</li> </ul>  |  |                      |                       |  |  |
|                     | <ul> <li><u>Section 10 "Packing information"</u>: added</li> </ul>  |  |                      |                       |  |  |
|                     | <ul> <li><u>Section 11 "Soldering</u>": added</li> </ul>  |  |                      |                       |  |  |
|                     | <ul> <li>Section 13 "L</li> </ul>   | egal information": updated                     |                      |                       |  |  |
| PDTA123J_SERIES v.4 | 20040802  | Product data sheet                             | -                    | PDTA123J_SERIES v.3   |  |  |
| PDTA123J SERIES v.3 | 20030414  | Product specification                          | -                    | _                     |  |  |

### **13. Legal information**

#### 13.1 Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PDTA123J SER

#### PNP resistor-equipped transistors; R1 = 2.2 k $\Omega$ , R2 = 47 k $\Omega$

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